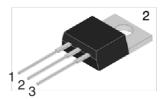
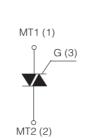


#### **TO-220AB**





#### **On-State Current**

**Gate Trigger Current** 

12 Amp

≤ 50 mA

### **Off-State Voltage**

400 V ÷ 800 V

#### **FEATURES**

- Glass/passivated die junctions
- Medium current Triac
- Low thermal resistance
- High commutation
- High surge current capability
- Low forward voltage drop
- Solder dip 260°C, 10s
- Component in accordance to RoHS 2011/65/EU and WEEE 2002/96/EC
- Meets MSL level 3, per J-STD-020, LF maximum peak of 260° C

#### **MECHANICAL DATA**

- Case: TO-220AB. Epoxy meets UL 94V-0 flammability rating.
- Polarity: As marked on the body.
- **Terminals:** Matte tin plated leads, solderable per MIL-STD-750 Method 2026, J-STD-002 and JESD22-B102. Consumer grade, meets JESD 201 class 1A whisker test.

#### **TYPICAL APPLICATIONS**

 Used on inductive loads, thanks to their high commutation performances.

## Maximun Ratings and Electrical Characteristics at 25°C

| SYMBOL              | PARAMETER                                 | CONDITIONS  | Value      | Unit   |
|---------------------|---|---|------------|--------|
| I <sub>T(RMS)</sub> | RMS On-state Current (full sine wave)     | All Conduction Angle, T <sub>c</sub> = 105 °C               | 12         | А      |
| I <sub>TSM</sub>    | Non-repetitive On-State Current           | Full Cycle, 60 Hz (t = 16.7 ms)                             | 110        | А      |
| I <sub>TSM</sub>    | Non-repetitive On-State Current           | Full Cycle, 50 Hz (t = 20 ms)                               | 100        | А      |
| I <sup>2</sup> t    | Fusing Current                            | tp = 10 ms, Half Cycle                                      | 50         | $A^2s$ |
| I <sub>GM</sub>     | Peak Gate Current                         | 20 μs max. Tj = 125 °C                                      | 4          | А      |
| P <sub>G(AV)</sub>  | Average Gate Power Dissipation            | Tj = 125 °C   | 1          | W      |
| dI/dt               | Critical rate of rise of on-state current | I <sub>G</sub> = 2x I <sub>GT</sub> , t <sub>r</sub> ≤100ns | 50         | A/µs   |
|                     |   | f = 120 Hz, T <sub>j</sub> = 125 °C                         |            |        |
| Tj                  | Operating Temperature                     |   | (-40 +125) | °C     |
| T <sub>stg</sub>    | Storage Temperature                       |   | (-40 +150) | °C     |
| T <sub>sld</sub>    | Soldering Temperature                     | 10s max   | 260        | °C     |

| SYMBOL            | PARAMETER                         |     | Unit |     |   |
|-------------------|-----------------------------------|-----|------|-----|---|
| OTMBOL            |                                   | D   | M    | N   |   |
| $V_{DRM}/V_{RRM}$ | Repetitive Peak Off State Voltage | 400 | 600  | 800 | V |

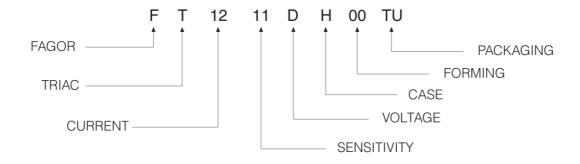


## Electrical Characteristics at Tamb = 25 °C

| SYMBOL                             | DADAMETED                     | CONDITIONS   |                                   | Ouadrant |     | SEI  |     | NSITIVITY |      |
|------------------------------------|-------------------------------|--|-----------------------------------|----------|-----|------|-----|-----------|------|
| STWIBUL                            | PARAMETER                     |  |                                   | Quadrant |     | 11   | 14  | 16        | Unit |
| I <sub>GT</sub> <sup>(1)</sup>     | Gate Trigger Current          | $V_D = 12 V_{DC}, R_L = 339$   | $\Omega$ , $T_j = 25  ^{\circ}C$  | Q1÷Q3    | MAX | 25   | 35  | 50        | mA   |
| V <sub>GT</sub>                    | Gate Trigger Voltage          | $V_D = 12 V_{DC}, R_L = 339$   | $\Omega$ , $T_j = 25$ °C          | Q1÷Q3    | MAX | 1.3  |     |           | V    |
| $V_{GD}$                           | Gate Non Trigger Voltage      | $V_D = V_{DRM}, R_L = 3.3 \text{ Kg}$                                  | $\Omega$ , $T_j = 125  ^{\circ}C$ | Q1÷Q3    | MIN | 0.2  |     | V         |      |
| I <sub>H</sub> <sup>(2)</sup>      | Holding Current               | $I_T = 100 \text{ mA,Gate ope}$  | en, T <sub>j</sub> = 25 °C        |          | MAX | 25   | 35  | 50        | mA   |
| IL                                 | Latching Current              | $I_{G} = 1.2 I_{GT}, T_{j} = 25 ° C$                                   | C                                 | Q1,Q3    | MAX | 40   | 50  | 70        | mA   |
|                                    |                               |  |                                   | Q2       | MAX | 50   | 60  | 80        | mA   |
| dV/dt (2)                          | Critical Rate of Voltage Rise | $V_D = 0.67 \times V_{DRM}$ , Ga                                       | te open                           |          | MIN | 200  | 500 | 1000      | V/µs |
|                                    |                               | T <sub>j</sub> = 125 °C  |                                   |          |     |      |     |           |      |
| (dl/dt)c (2)                       | Critical Rate of Current Rise | $(dv/dt)c = 0.1 V/\mu s$   | $T_j = 125  ^{\circ}\text{C}$     |          | MIN | -    | -   | -         | A/ms |
|                                    |                               | (dv/dt)c = 10 V/µs   | $T_j = 125  ^{\circ}\text{C}$     |          | MIN | -    | -   | -         |      |
|                                    |                               | without snubber  | $T_j = 125  ^{\circ}\text{C}$     |          | MIN | 5.3  | 6.5 | 12        |      |
| V <sub>TM</sub> <sup>(2)</sup>     | On-state Voltage              | $I_T = 17 \text{ Amp, tp} = 380 \mu\text{s,T}_j = 25 ^{\circ}\text{C}$ |                                   |          | MAX | 1.55 |     | V         |      |
| V <sub>t (o)</sub> (2)             | Threshold Voltage             | T <sub>j</sub> = 125 °C  |                                   |          | MAX | 0.85 |     | V         |      |
| r <sub>d</sub> <sup>(2)</sup>      | Dynamic resistance            | T <sub>j</sub> = 125 °C  |                                   |          | MAX | 35   |     |           | mΩ   |
| I <sub>DRM</sub> /I <sub>RRM</sub> | Off-State Leakage Current     | $V_D = V_{DRM}$  | T <sub>j</sub> = 125 °C           |          | MAX |      | 1   |           | mA   |
|                                    |                               | $V_R = V_{RRM}$ ,  | $T_j = 25  ^{\circ}C$             |          | MAX |      | 5   |           | μΑ   |
| R <sub>th(j-c)</sub>               | Thermal Resistance            | for AC 360° conducti   | on angle                          |          |     |      | 1.4 |           | °C/W |
|                                    | Junction-Case                 |  |                                   |          |     |      |     |           |      |
| R <sub>th(j-a)</sub>               | Thermal Resistance            |  |                                   |          |     | 60   |     |           | °C/W |
|                                    | Junction-Ambient              |  |                                   |          |     |      |     |           |      |

<sup>(1)</sup> Minimum I<sub>GT</sub> is guaranted at 5% of I<sub>GT</sub> max.

### **Part Number Information**



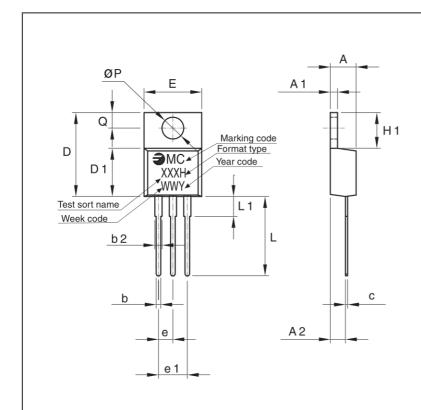
<sup>(2)</sup> For either polarity of electrode MT2 voltage with reference to electrode MT1.



## **Ordering information**

| PREFERRED P/N | PACKAGE CODE | DELIVERY MODE | BASE QUANTITY | UNIT WEIGHT (g) |
|---------------|--------------|---------------|---------------|-----------------|
| FT1216DH 00TU | TU           | TUBE          | 1000          | 2.30            |

# Package Outline Dimensions: (mm) TO-220AB



|      | DIMEN      | SIONS |  |  |
|------|------------|-------|--|--|
| REF. | Milimeters |       |  |  |
|      | Min.       | Max.  |  |  |
| А    | 4.47       | 4.67  |  |  |
| A1   | 1.17       | 1.37  |  |  |
| A2   | 2.52       | 2.82  |  |  |
| b    | 0.71       | 0.91  |  |  |
| b2   | 1.17       | 1.37  |  |  |
| С    | 0.31       | 0.53  |  |  |
| D    | 14.65      | 15.35 |  |  |
| D1   | 8.50       | 8.90  |  |  |
| E    | 10.01      | 10.36 |  |  |
| е    | 2.51       | 2.57  |  |  |
| e1   | 4.98       | 5.18  |  |  |
| H1   | 6.15       | 6.45  |  |  |
| L    | 13.40      | 13.96 |  |  |
| L1   | 3.56       | 3.96  |  |  |
| Р    | 3.735      | 3.935 |  |  |
| Q    | 2.59       | 2.89  |  |  |

Mounting Torque 0.8 N.m



# Ratings and Characteristics (Ta 25 °C unless otherwise noted)

Fig. 1: Maximum power dissipation versus RMS on-state current (full cycle)

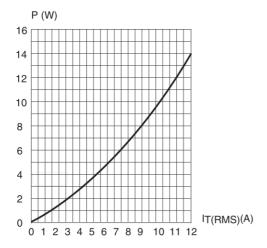


Fig. 3:: Relative variation of thermal impedance versus pulse duration

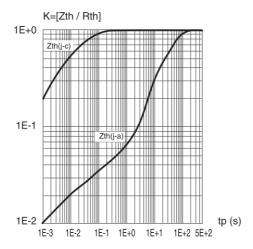


Fig. 5: Surge peak on-state current versus number of cycles

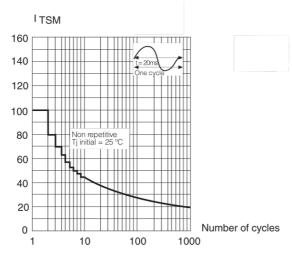


Fig. 2: RMS on-state current versus case temperature (full cycle)

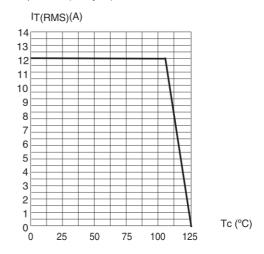


Fig. 4: On-state characteristics (maximum values)

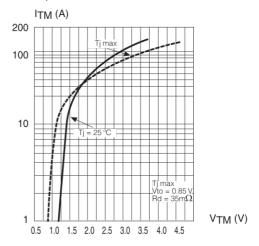
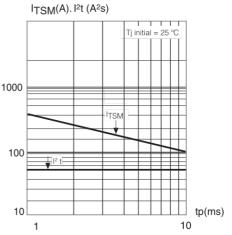


Fig. 6: Non repetitive surge peak on-state current for a sinusoidal pulse with width: tp < 10 ms, and corresponding value of l²t.







# Ratings and Characteristics (Ta 25 °C unless otherwise noted)

Fig. 7: Relative variation of gate trigger current, holding current and latching versus junction temperature (typical values)

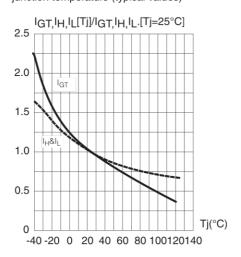
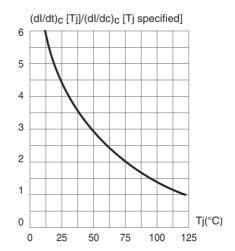


Fig. 8: Relative variation of critical rate of decrease of main current versus junction temperature





### **Revision History**

| Date Revision |   | Description of Changes  |  |  |
|---------------|---|---|--|--|
| 14-Jun-2011   | 0 | Original Data Sheet   |  |  |
| 10-May-2013   | 1 | Change values of: $I_{T(RMS)}/I_{TSM}/I^2t/V_{TM}/V_{t(o)}/r_d/R_{th(j-c)}$ |  |  |
| 3-Jul-2013    | 2 | Rescale curves in Figure 7  |  |  |

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